



PSE Technology Corporation

SPECIFICATION FOR APPROVAL

CUSTOMER _____

NOMINAL FREQUENCY 26.000000 MHz

PRODUCT TYPE **TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL**

SPEC. NO. (P/N) FL260WFMT1

CUSTOMER P/N _____

ISSUE DATE June 23, 2016

VERSION A

APPROVED	PREPARED	QA
APPROVED BY CUSTOMER :		AVL Status
Please return one copy with approval to PSE-TW		

PSE Technology Corporation

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- *Pb-free
- *RoHS Compliant
- *HF-Halogen Free
- *REACH Compliant

*** A company of **PERICOM Semiconductor Corporation** ***

Pericom Internal Reference NO. FL2600192Z

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ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	26.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	12	pF	
Calibration Tolerance	FL	±7	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +100	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±17	ppm	Reference to the Frequency at 25°C
Operating Drive Level		100	μW	
Maximum Drive Level		200	μW	
Equivalent Series Resistance	ESR	30	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Trim Sensitivity	TS	10	ppm/pF	Min.
Aging at 25°C		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	MΩ	Min

※ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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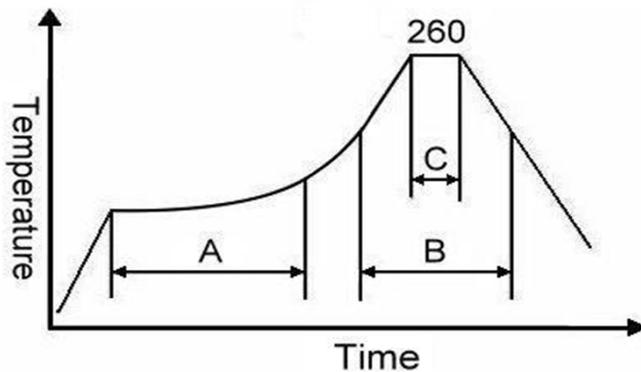
RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

- a) FINE LEAK TEST: JESD22-A109 (Condition 1A)
- b) GROSS LEAK TEST: JESD22-A109 (Condition C)
- c) MOISTURE RESISTANCE: JESD22-A113
- d) SHOCK: JESD22-B104 (Condition B)
- e) SOLDERABILITY : (RoHS version): J-STD-002
- f) VIBRATION: JESD22-B103
- g) SOLVENT RESISTANCE: JESD22-B107
- h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



Note:

	Stage	Temperature	Time
A	Preheat	150~200°C	60~120 Sec
B	Primary Heat	217°C	60~150 Sec
C	Peak	260°C	10 Sec

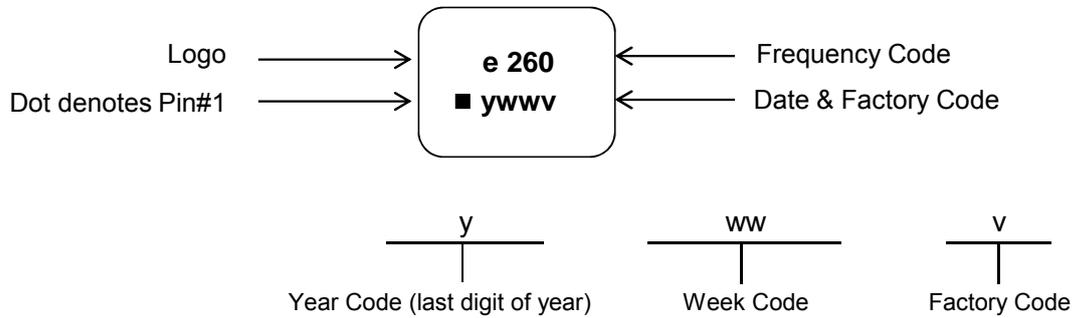
For soldering reflow profile and reliability test ratings go to: <http://www.pericom.com/pdf/sre/reflow.pdf>

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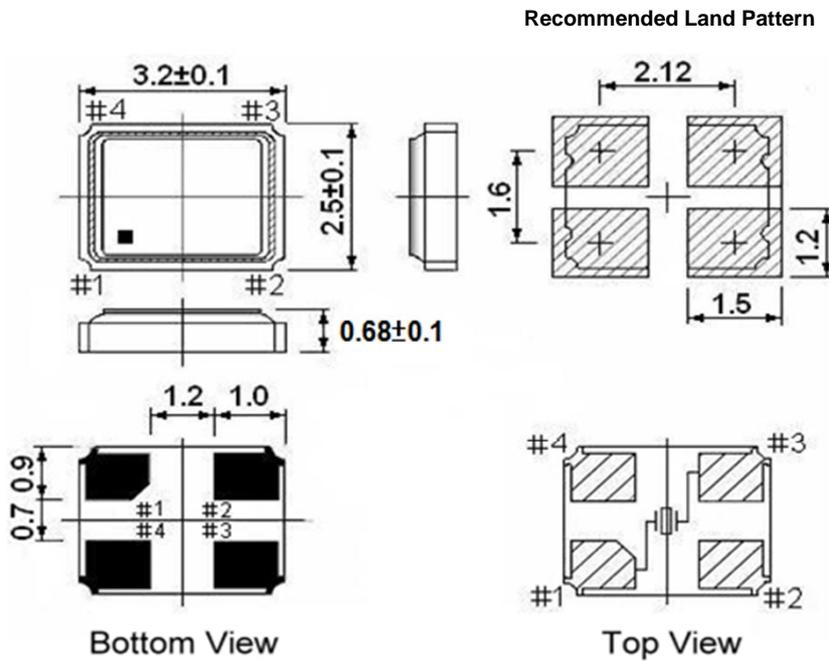
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MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)



**** Recommended - Pin 1 & 3 : CRYSTAL
Pin 2 & 4 : GND**

Notes:

1. Package drawings are for reference only, and the appearances of objects may vary.
Actual packages are based on the real product.
2. The marking dot denotes Pin#1.
3. The position and shape of the chamfer pin may vary and are based on the real product.

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PACKING

